

# CMOS/TTL CLOCK OSCILLATOR

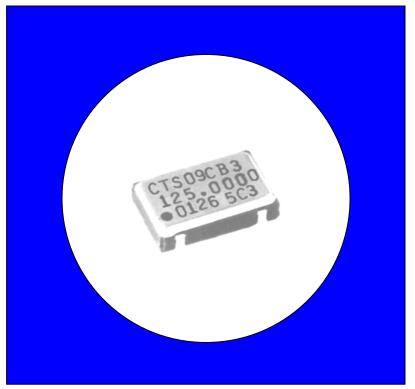
# Model CB3 & CB3LV Technical Data

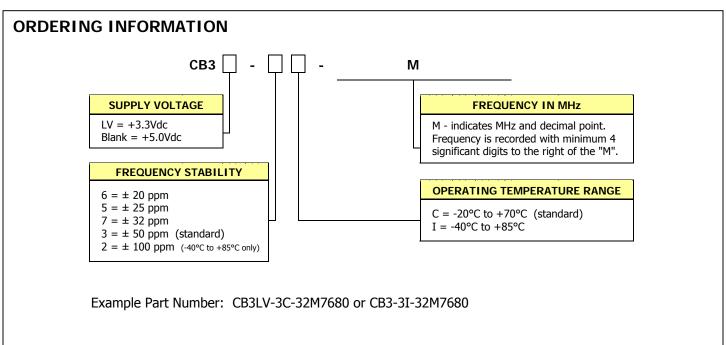
# **FEATURES**

- Standard 7.5x5mm Surface Mount Footprint
- CMOS/TTL Compatible
- Frequency Range 1.5 160 MHz
- Frequency Stability, ±50 ppm Standard (±25 ppm and ±20 ppm available)
- +3.3Vdc or +5.0Vdc Operation
- Operating Temperature to -40°C to +85°C
- Output Enable Standard
- Tape & Reel Packaging
- RoHS Compliant



The CB3/CB3LV is a ceramic packaged Clock oscillator offering reduced size and enhanced stability. The small size means it is perfect for any application. The enhanced stability means it is the perfect choice for today's communications applications that require tight frequency control.







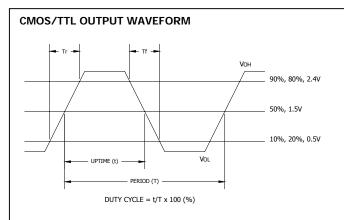
# **ELECTRICAL CHARACTERISTICS**

	PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Absolute Maximums	Maximum Supply Voltage	V <sub>cc</sub>	-	-0.5	-	7.0	V
	Storage Temperature	$T_{STG}$	-	-55	-	125	°C
	Frequency Range	f <sub>O</sub>	-	1.5	-	160	MHz
	Frequency Stability (See Note 1 and Ordering Information)	Δf/f <sub>O</sub>	-	-	ı	20,25,32, 50 or 100	± ppm
	Operating Temperature Commercial Industrial	T <sub>A</sub>	-	-20 -40	25	70 85	°C
	Supply Voltage		± 10 %				
	CB3	V <sub>CC</sub>		4.5	5.0	5.5	V
	CB3LV			3.0	3.3	3.6	
	Supply Current CB3	I <sub>cc</sub>	1.5 MHz to 20 MHz	- - -	10 30 40	25 50 100	mA
	CB3LV		$\begin{array}{llllllllllllllllllllllllllllllllllll$	-	7 20 30	12 40 60	
	Output Load	$C_L$	1.5 MHz to 50 MHz 50.1 MHz to 80 MHz 80.1 MHz to 160 MHz		1 1	50 30 15	pF
	Output Voltage Levels						
neters	Logic '1' Level	$V_{OH}$	CMOS Load 10 TTL LOAD	V <sub>CC</sub> - 0.5V V <sub>CC</sub> - 0.6V	-	-	V
ara	Logic '0' Level	V <sub>OL</sub>	CMOS or TTL Load	-	-	0.4	
Ē	Output Current						
lvefc	Logic '1' Level	$I_{OH}$	$V_{OH} = 3.9V/2.2V$ $V_{CC} = 4.5V/3.0V$	-	-	-16/-8	mA
N K	Logic '0' Level	$I_{OL}$	$V_{OL} = 0.4V$ $V_{CC} = 4.5V/3.0V$	-	-	+16/+8	111/1
land	Output Duty Cycle	SYM	@ 50% Level	45	-	55	%
Electrical and Waveform Parameters	Rise and Fall Time CB3		@ 10% - 90% Levels   1.5 MHz to 20 MHz	-	8 4	10 8	
	CB3LV	$T_R$ , $T_F$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	- - -	2.5 6 3 1.5	5 8 4 3	ns
	Start Up Time	Ts	Application of V <sub>CC</sub>	-	-	10	ms
	Enable Function (See Note 2)	J					
	Enable Input Voltage	$V_{\mathrm{IH}}$	Pin 1 Logic '1', Output Enabled	2	-	-	V
	Disable Input Voltage	$V_{\mathrm{IL}}$	Pin 1 Logic '0', Output Disabled	-	-	0.8	
	Enable Time		Pin 1 Logic '1'				
	CB3	$T_{PLZ}$		-	-	100	ns
	CB3LV			-	-	10	ms
	Phase Jitter	tjms	Bandwidth 12 KHz - 20 MHz	-	< 1	-	ps RMS

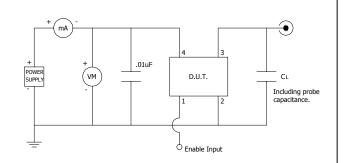
### Notes

<sup>1.</sup> Inclusive of initial tolerance at time of shipment, changes in supply voltage, load, temperature and first year aging at an average operating temperature of +40 °C.

<sup>2.</sup> Reference CTS Application Note 014-0002-0.



# TEST CIRCUIT, CMOS LOAD



### **ENABLE TRUTH TABLE**

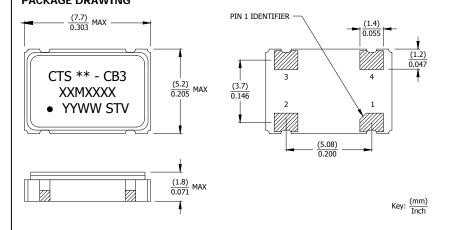
PIN 1	PIN 3
Logic '1'	Output
Open	Output
Logic '0'	High Imp

**D.U.T. PIN ASSIGNMENTS** 

PIN	SYMBOL	DESCRIPTION
1	EOH	Enable Input
2	GND	Circuit & Package Ground
3	Output	RF Output
4	$V_{CC}$	Supply Voltage

# MECHANICAL SPECIFICATIONS

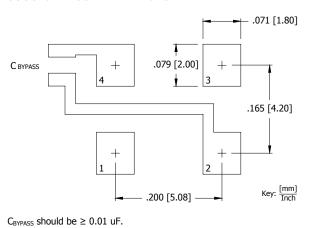




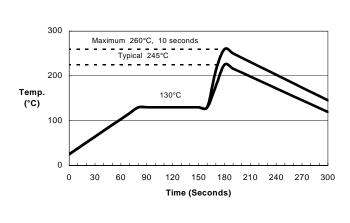
### MARKING INFORMATION

- 1. \*\* Manufacturing Site Code.
- 2. XXMXXXX Frequency marked with 4 significant digits after the 'M'.
- 3. YYWW Date code, YY year, WW week.
- 4. ST Frequency stability/temperature code. (Reference Ordering Information.)
- 5. V Voltage code. 3 = 3.3V, 5 = 5.0V.

# SUGGESTED SOLDER PAD GEOMETRY

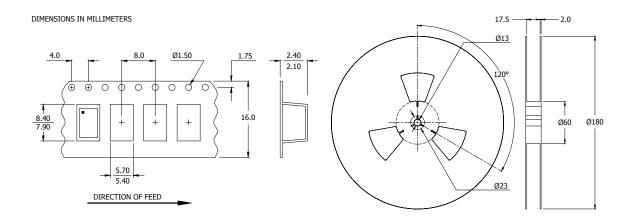


### SUGGESTED REFLOW PROFILE





# TAPE AND REEL INFORMATION



Device quantity is 1,000 pieces per 180mm reel.

# **ENVIRONMENTAL SPECIFICATIONS**

Temperature Cycle: 400 cycles from -55°C to +125°C, 10 minute dwell at each temperature, 1

minute transfer time between temperatures.

Mechanical Shock: 1,500g's, 0.5mS duration, ½ sinewave, 3 shocks each direction along 3

mutually perpendicular planes (18 total shocks).

Sinusoidal Vibration: 0.06 inches double amplitude, 10 to 55 Hz and 20g's, 55 to 2,000 Hz, 3 cycles

each in 3 mutually perpendicular planes (9 times total).

Gross Leak: No leak shall appear while immersed in an FC40 or equivalent liquid at

+125°C for 20 seconds.

Fine Leak: Mass spectrometer leak rates less than 2x10<sup>-8</sup> ATM cc/sec air equivalent.

Resistance to Solder Heat: Product must survive 3 reflows of +260°C peak, 10 seconds maximum.

High Temperature Operating Bias: 2,000 hours at +125°C, maximum bias, disregarding frequency shift.

Frequency Aging: 1,000 hours at  $+85^{\circ}$ C, full bias, less than  $\pm 5$  ppm shift.

# **QUALITY AND RELIABILITY**

Quality systems meet or exceed the requirements of ISO 9000:2000 standards. Reliability audits are performed on this or similar products with results available upon request.